Panasonic

MA26V03

Silicon epitaxial planar type

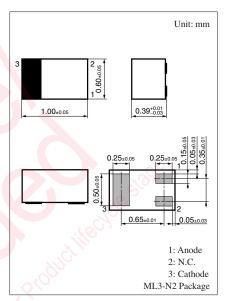
For VCO

Features

- \bullet Good linearity and large capacitance-ratio in $C_D V_R$ relation
- Small series resistance r_D
- High frequency type by this low capacitance

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V _R	6	V	
Junction temperature	Tj	125	°C	
Storage temperature	T _{stg}	-55 to +125	°C	

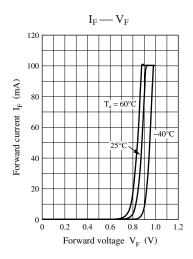


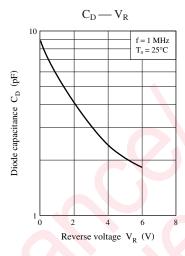
Marking Symbol: 2F

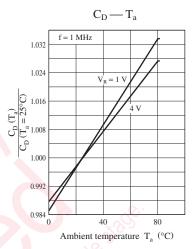
■ Electrical Characteristics $T_a = 25$ °C ± 3°C

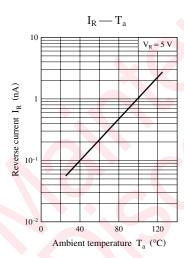
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current	I_R	$V_R = 5 \text{ V}$	000	0//	10	nA
Diode capacitance	C_{D1V}	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$	5.20	0.	5.80	pF
	C_{D4V}	$V_R = 4 \text{ V, f} = 1 \text{ MHz}$	2.10		2.58	
Capacitance ratio	C _{D1V} / C _{D4V}	95: 67: 10	2.1		2.6	_
Series resistance *	r_{D}	$V_R = 4 \text{ V, f} = 470 \text{ MHz}$			0.3	Ω

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. Absolute frequency of input and output is 470 MHz.
 - 3. *: Measuring instrument: YHP MODEL 4191A RF IMPEDANCE ANALYZER









2 SKD00074CED

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